

ORDER DATA

| | | | |
|---|-------------------|-------------------------------|------------------------------|
| Warehouse: FBS | Del Terms: DDP | Billing Address: 020155 | Ship To Address: 200 |
| Sales Order: 30565846 | Financial Co: 106 | CEAC INTERNATIONAL LIMITED | Microchip Technology Chengdu |
| Web Order: 0 | Inter. Co.: | Room 9, 3/F., Sun Ling Plaza, | RM2502,25Floor,Tower 1,Plaza |
| Web Cust Type: 1 - Business | | 30 On Kui Street, Fanling, | Central,No.8,Shun Cheng St., |
| End Customer: HUB WH ZG TECH CO LTD - WUHAN | | N.T. | Chengdu |
| Application: 3D Scanner Motherboard | | Hong Kong | Attn: Cher Zhou |
| Distributor: CEAC INTERNATIONAL LIMITED | | Hong Kong | China |
| Potential Qty/Yr: 100000.00 | | Hong Kong | China |
| Doc Sets | | | Attention: CEAC_Kevin Xie |
| BFDC: MASSCONSOL_CN | MCDC: CN_MASS | | Telephone: |
| AFDC: | Ship Region: CNP | | E-mail: will.yu@cecport.com |

ORDER LINE DATA

| Line | Part | Quantity | PDD | Lead | Package |
|------|---------------|----------|------------|------|---------|
| 1 | LAN7801-I/9JX | 10 | 01-01-2026 | 64 | VQFN |

LOT DETAIL

| Line | MPC | Lot | Qty (PCS) | Run | Expiry Date | Retest Date | PMDC | RTDC | Tran Pr | COO |
|------|--------------|-----------------|--------------|--------------|-------------|-------------|------|------|---------|-----|
| 1 | STB0379JXAB1 | 252400111000ASE | 10 | b12302025sb1 | 09-04-2028 | 09-07-2026 | 2437 | 2437 | 0.864 | TW |

WAFER SIZE:12 WAFER START: TC14 PROBE: TC14 ASSY: ASE TEST: MTAI TEST TYPE: 01 PRICE METH: Cost Plus TRACE CODES: 24379BR/24379CQ

PICKING DATA

| Line | MPC | Location | Lot | Qty (PCS) | Notes |
|------|-----|----------|-----|--------------|-------------|
| 1 | | SX35-01 | | 10 | 24379BR |

Customer Instructions :
 Tax ID: 91441900595890996D

Delivery Instruction for ALL WH :
 No Instructions

Delivery Instruction for FBS WH :
 No Instructions

Sales Order :
 No Instructions

Sales Order Line :
 No Instructions


PICK LIST

2025-12-29T16:56:50



17992837



17992837

Earliest PDD

01-01-2026

China

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P-CN-CEA-S17992837

PRODUCT SAMPLE

BAR CODES

Carrier: TBD



MICROCHIP TECHNOLOGY CHENGDU



RM2502,25FLOOR,TOWER 1,PLAZA



CENTRAL,NO.8,SHUN CHENG ST.,



CEAC KEVIN XIE



CHENGDU



ATTN: CHER ZHOU



CHINA



CHINA



WILL.YU@CECPORT.COM



Pick List: _____ Pick Parts: _____ Pack: 072 P/L & Inv: _____ Inspector/QA _____

This shipment contains no coniferous wood packaging materials.

These commodities, technology or software were exported in accordance with applicable export control regulations. Diversion contrary to export controls is prohibited.

PICK LIST

2025-12-29T16:56:50



17992837



S17992837

Earliest PDD

01-01-2026

China

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Project: sds_pick Version: 5.6.2_ST-4.5 Event: sdshp92100100s2 Process: PICKLIST-P SSPage: Body